

**ACE2305B****P-Channel Enhancement Mode Field Effect Transistor**

Description

The ACE2305B uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected.

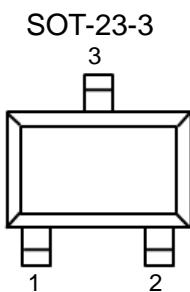
Features

- $V_{DS}=-20V$, $I_D=-4.3A$
- $R_{DS(ON)}<55m\Omega$ @ $V_{GS}=-4.5V$
- $R_{DS(ON)}<63m\Omega$ @ $V_{GS}=-2.5V$
- $R_{DS(ON)}<73m\Omega$ @ $V_{GS}=-1.8V$
- ESD Protected: 3000V HBM

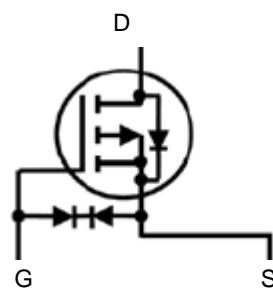
Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 8	V
Drain Current (Continuous)	I_D	-4.3	A
		-3.4	
Drain Current (Pulse)	I_{DM}	-32	A
Power Dissipation	P_D	1	W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Packaging Type

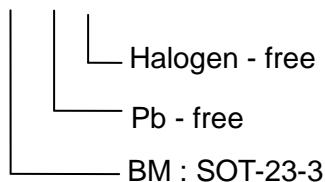


SOT-23-3	Description
1	Gate
2	Source
3	Drain



Ordering information

ACE2305B XX + H





ACE2305B

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Electrical Characteristics

 $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On/Off characteristics						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-16\text{V}, V_{GS}=0\text{V}$			-1	μA
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 8\text{V}, V_{DS}=0\text{V}$			± 10	nA
Static Drain-Source On-Resistance	$R_{DS(\text{ON})}$	$V_{GS}=-4.5\text{V}, I_D=-4\text{A}$		42	55	$\text{m}\Omega$
		$V_{GS}=-2.5\text{V}, I_D=-4\text{A}$		48	63	
		$V_{GS}=-1.8\text{V}, I_D=-2\text{A}$		56	73	
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.3	-0.65	-1	V
Forward Transconductance	g_{FS}	$V_{DS}=-5\text{V}, I_D=-4\text{A}$	8	16		S
Maximum Body-Diode Continuous Current	I_S				-2.2	A
Drain Forward Voltage	V_{SD}	$I_S=-1\text{A}, V_{GS}=0\text{V}$		-0.81	-1	V
Switching characteristics ⁽³⁾						
Total Gate Charge	Q_g	$V_{DS}=-10\text{V}, I_D=-4\text{A}$ $V_{GS}=-4.5\text{V}$		4.59	5.97	nC
Gate-Source Charge	Q_{gs}			2.14	2.78	
Gate-Drain Charge	Q_{gd}			2.51	3.26	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=-10\text{V}, R_L=2.5\Omega$ $I_D=-4\text{A}, V_{GEN}=-4.5\text{V}$ $R_G=3\Omega$		965.2	1930.4	ns
Turn-On Rise Time	t_f			1604	3208	
Turn-Off Delay Time	$t_{d(off)}$			7716	15432	
Turn-Off Fall Time	t_f			3452	6904	
Dynamic characteristics ⁽³⁾						
Input Capacitance	C_{iss}	$V_{DS}=-10\text{V}, V_{GS}=0\text{V}$ $f=1.0\text{MHz}$		36.45		pF
Output Capacitance	C_{oss}			128.57		
Reverse Transfer Capacitance	C_{rss}			15.17		

Note: 1. Pulse width limited by maximum junction temperature

2. Pulse test: $PW \leq 300\text{us}$, duty cycle $\leq 2\%$
3. For design AID only, not subject to production testing.
4. Switching time is essentially independent of operating temperature.



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Typical Performance Characteristics

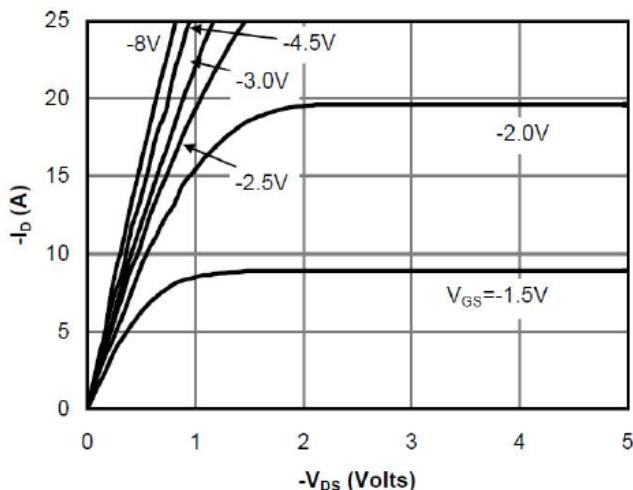


Fig 1: On-Region Characteristics

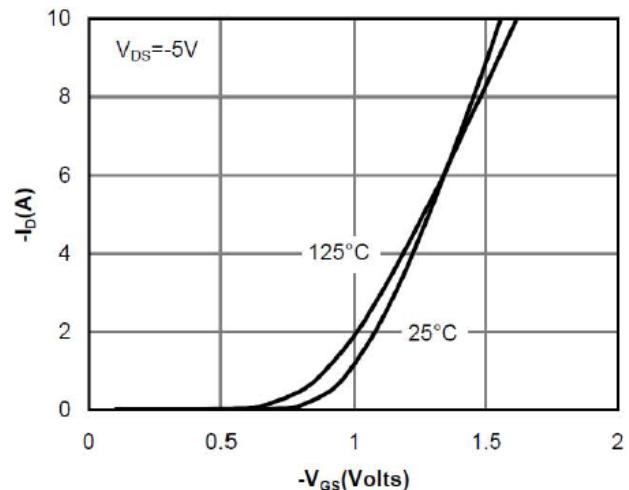


Figure 2: Transfer Characteristics

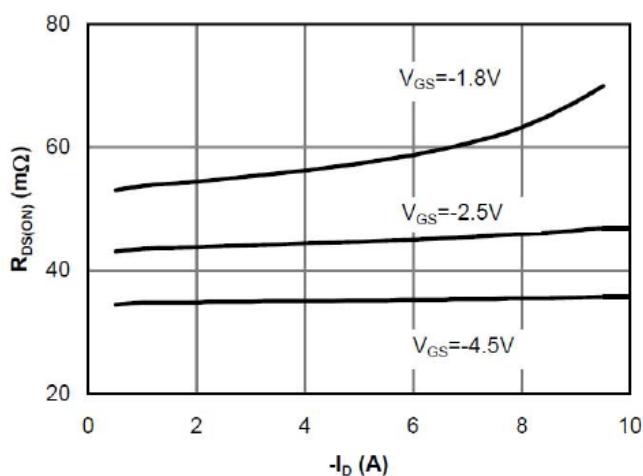


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

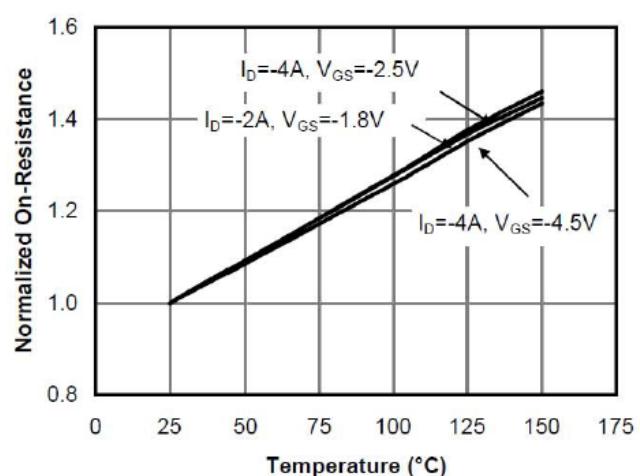


Figure 4: On-Resistance vs. Junction Temperature

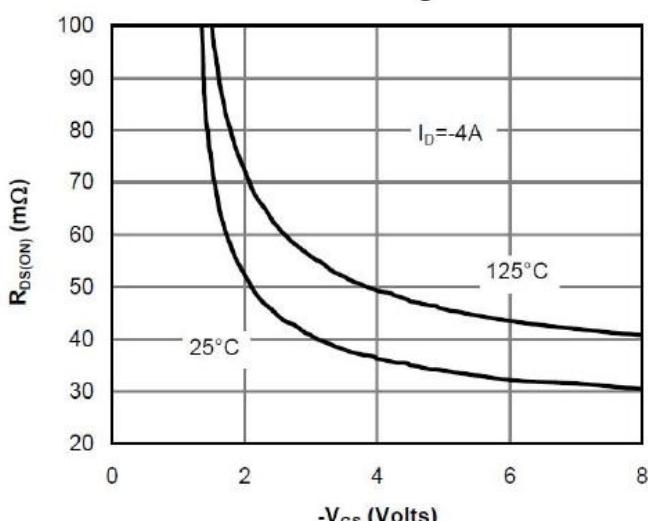


Figure 5: On-Resistance vs. Gate-Source Voltage

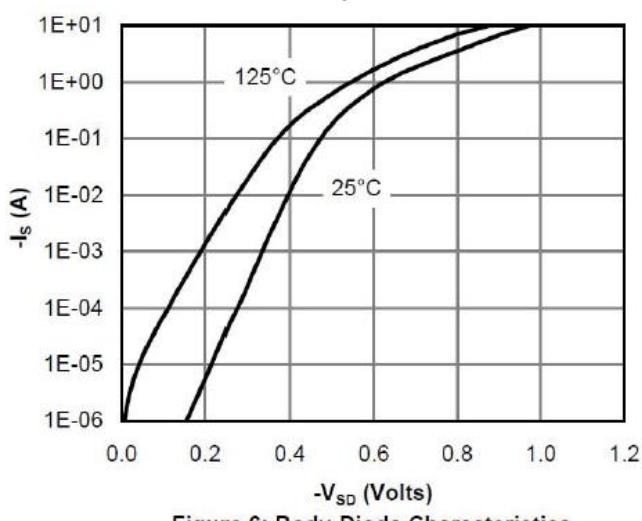


Figure 6: Body-Diode Characteristics



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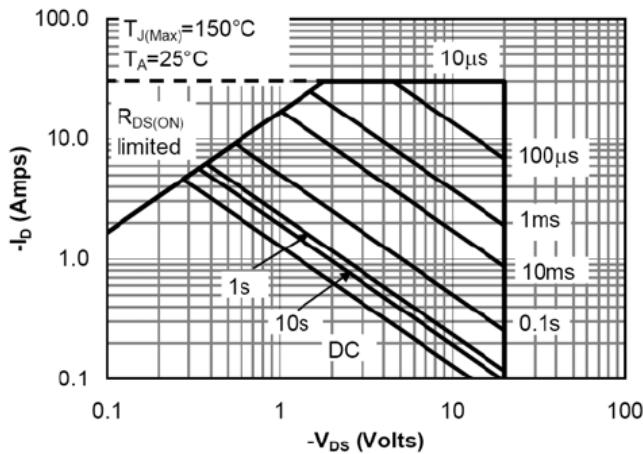


Figure 7: Maximum Forward Biased Safe Operating Area

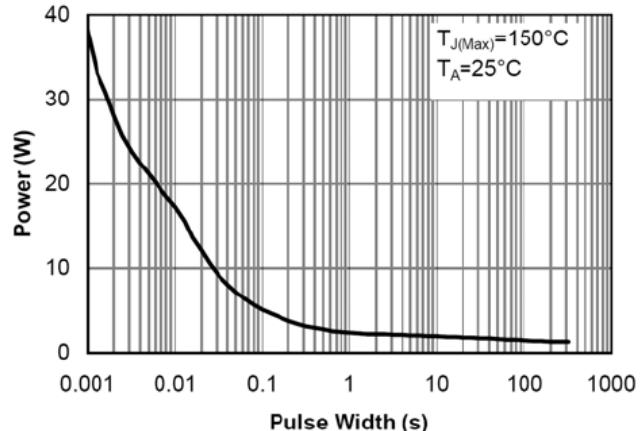


Figure 8: Single Pulse Power Rating Junction-to-Ambient

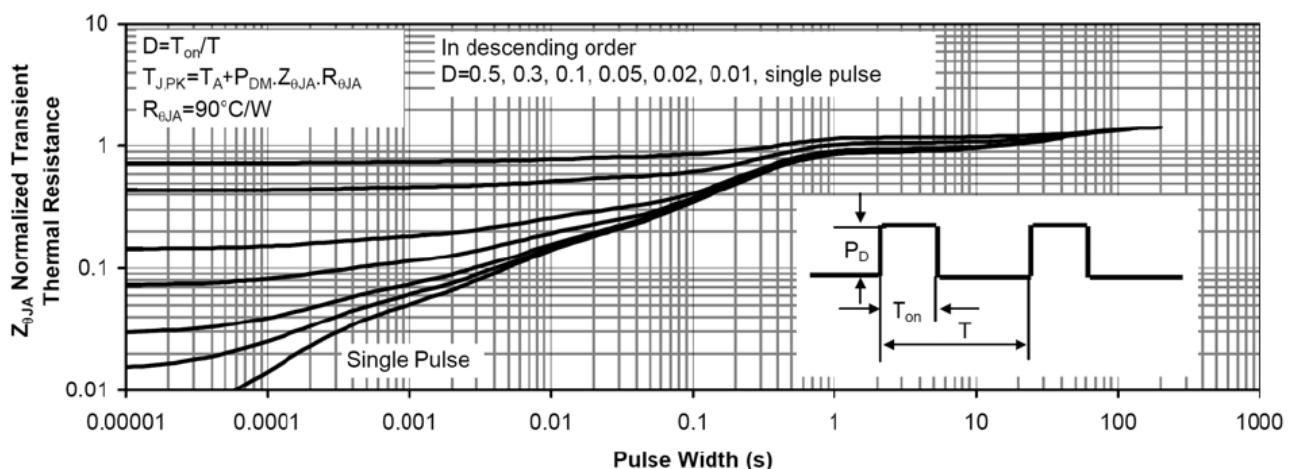


Figure 9: Normalized Maximum Transient Thermal Impedance

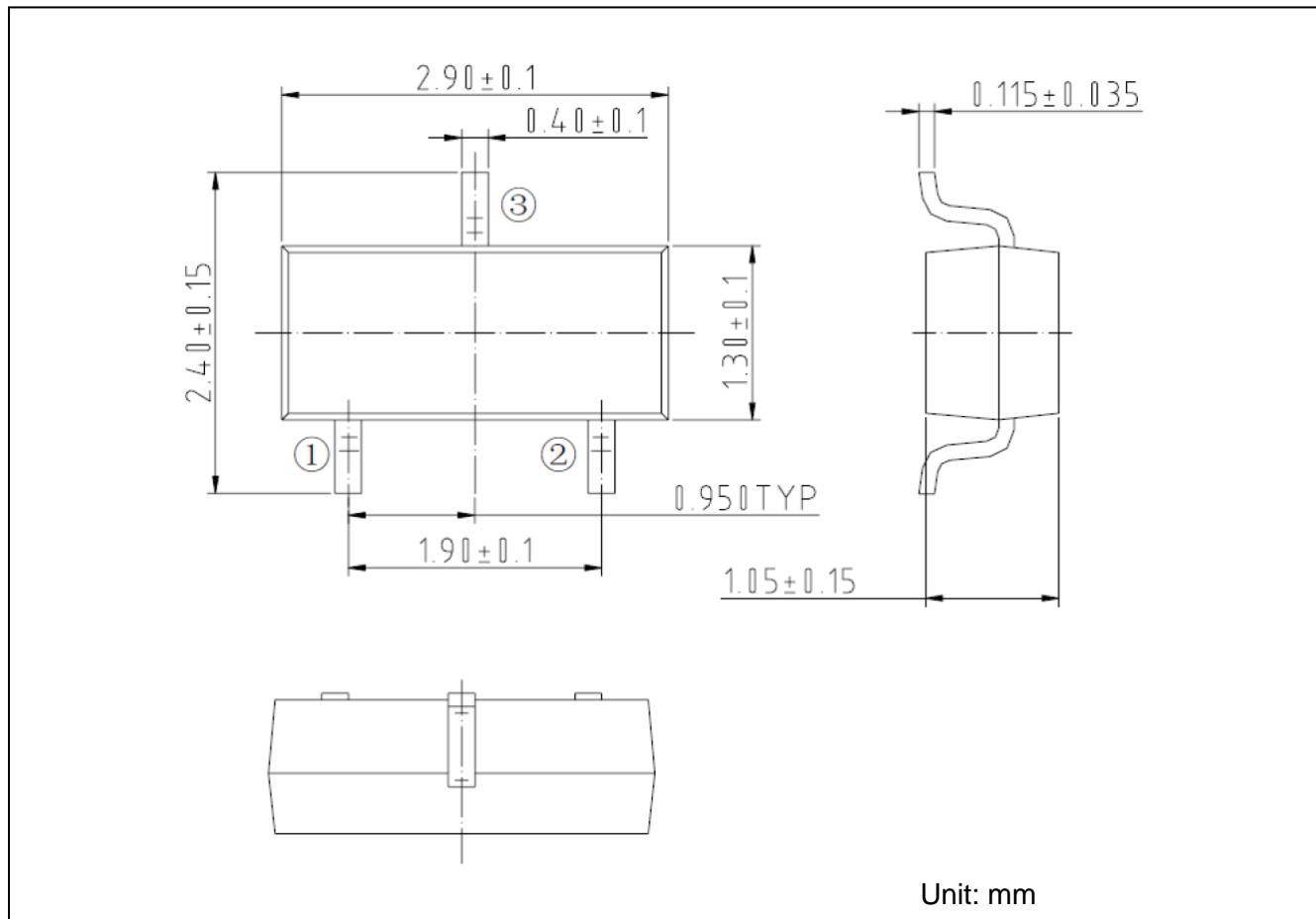


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Packing Information

SOT-23-3



Unit: mm



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Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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